PNP resistor-equipped transistors; R1 = 47 k Ω , R2 = 47 k Ω

Rev. 8 — 14 November 2011

Product data sheet

1. Product profile

1.1 General description

PNP Resistor-Equipped Transistor (RET) family in Surface-Mounted Device (SMD) plastic packages.

Table 1. Product overview

Type number	Package	Package			Package	
	NXP	JEITA	JEDEC	complement	configuration	
PDTA144EE	SOT416	SC-75	-	PDTC144EE	ultra small	
PDTA144EM	SOT883	SC-101	-	PDTC144EM	leadless ultra small	
PDTA144ET	SOT23	-	TO-236AB	PDTC144ET	small	
PDTA144EU	SOT323	SC-70	-	PDTC144EU	very small	

1.2 Features and benefits

- 100 mA output current capability
- Built-in bias resistors
- Simplifies circuit design

1.3 Applications

- Digital applications in automotive and industrial segments
- Control of IC inputs

- Reduces component count
- Reduces pick and place costs
- AEC-Q101 qualified
- Cost-saving alternative for BC847/857 series in digital applications
- Switching loads

1.4 Quick reference data

Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
V _{CEO}	collector-emitter voltage	open base	-	-	-50	V
lo	output current		-	-	-100	mA
R1	bias resistor 1 (input)		33	47	61	kΩ
R2/R1	bias resistor ratio		0.8	1	1.2	



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2. Pinning information

Pin	Description	Simplified outline	Graphic symbol
SOT23; S	OT323; SOT416		
1	input (base)	_	
2	GND (emitter)	3	
3	output (collector)	2	1 R1 R2 sym003
SOT883			
1	input (base)		
2	GND (emitter)		
3	output (collector)	2 Transparent top view	1 R1 R2 Sym003

3. Ordering information

Type number	Package	Package					
	Name	Description	Version				
PDTA144EE	SC-75	plastic surface-mounted package; 3 leads	SOT416				
PDTA144EM	SC-101	leadless ultra small plastic package; 3 solder lands; body 1.0 \times 0.6 \times 0.5 mm	SOT883				
PDTA144ET	-	plastic surface-mounted package; 3 leads	SOT23				
PDTA144EU	SC-70	plastic surface-mounted package; 3 leads	SOT323				

4. Marking

Table 5. Marking codes	
Type number	Marking code ^[1]
PDTA144EE	07
PDTA144EM	DR
PDTA144ET	*07
PDTA144EU	*07

[1] * = placeholder for manufacturing site code

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5. Limiting values

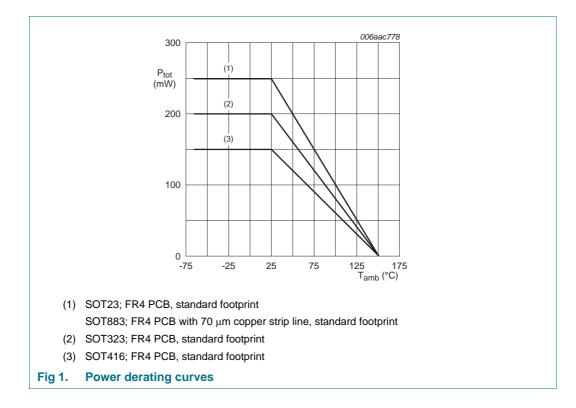
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CBO}	collector-base voltage	open emitter	-	-50	V
V _{CEO}	collector-emitter voltage	open base	-	-50	V
V _{EBO}	emitter-base voltage	open collector	-	-10	V
VI	input voltage				
	positive		-	+10	V
	negative		-	-40	V
lo	output current		-	-100	mA
I _{CM}	peak collector current	single pulse; $t_p \leq 1 ms$	-	-100	mA
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$			
	PDTA144EE (SOT416)		<u>[1][2]</u> _	150	mW
	PDTA144EM (SOT883)		[2][3]	250	mW
	PDTA144ET (SOT23)		<u>[1]</u> -	250	mW
	PDTA144EU (SOT323)		<u>[1]</u> -	200	mW
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C

Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard [1] footprint.

[2] Reflow soldering is the only recommended soldering method.

[3] Device mounted on an FR4 PCB with 70 µm copper strip line, standard footprint.

PNP resistor-equipped transistors; R1 = 47 k Ω , R2 = 47 k Ω



6. Thermal characteristics

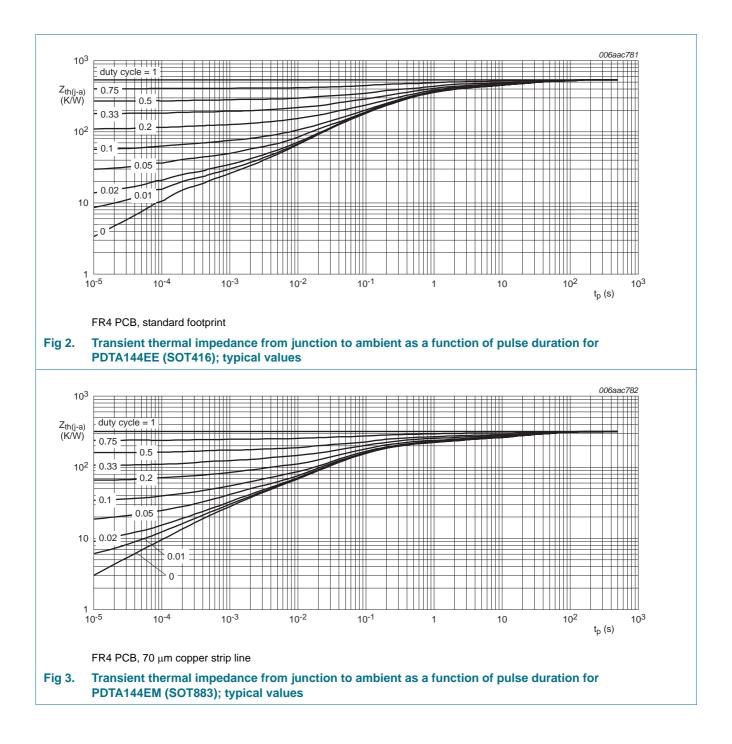
Table 7.	Thermal characteristics					
Symbol	Parameter	Conditions	Mir	n Typ	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air				
	PDTA144EE (SOT416)		[1][2] _	-	830	K/W
	PDTA144EM (SOT883)		[2][3]	-	500	K/W
	PDTA144ET (SOT23)		<u>[1]</u> -	-	500	K/W
	PDTA144EU (SOT323)		<u>[1]</u> -	-	625	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

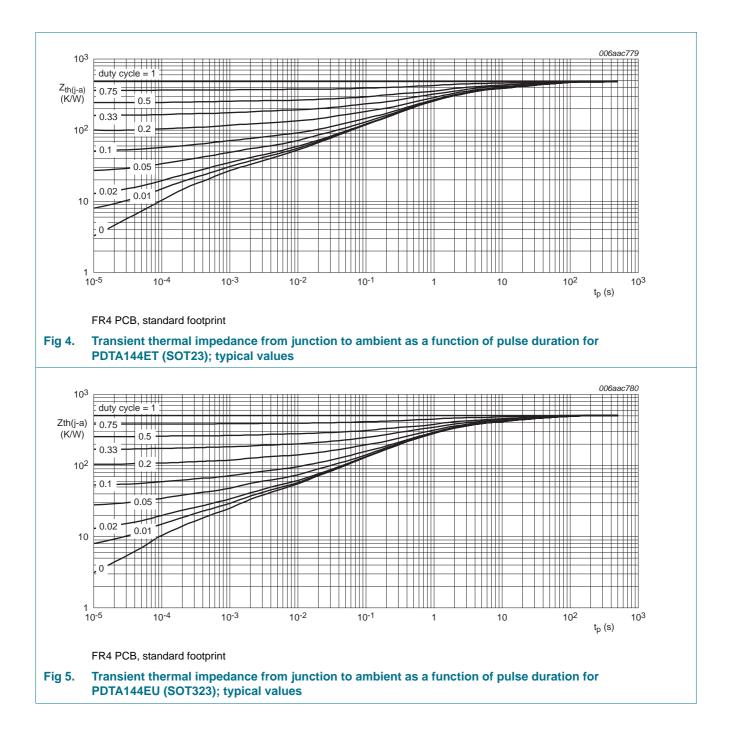
[2] Reflow soldering is the only recommended soldering method.

[3] Device mounted on an FR4 PCB with 70 μ m copper strip line, standard footprint.

PDTA144E series



PDTA144E series



PNP resistor-equipped transistors; R1 = 47 k Ω , R2 = 47 k Ω

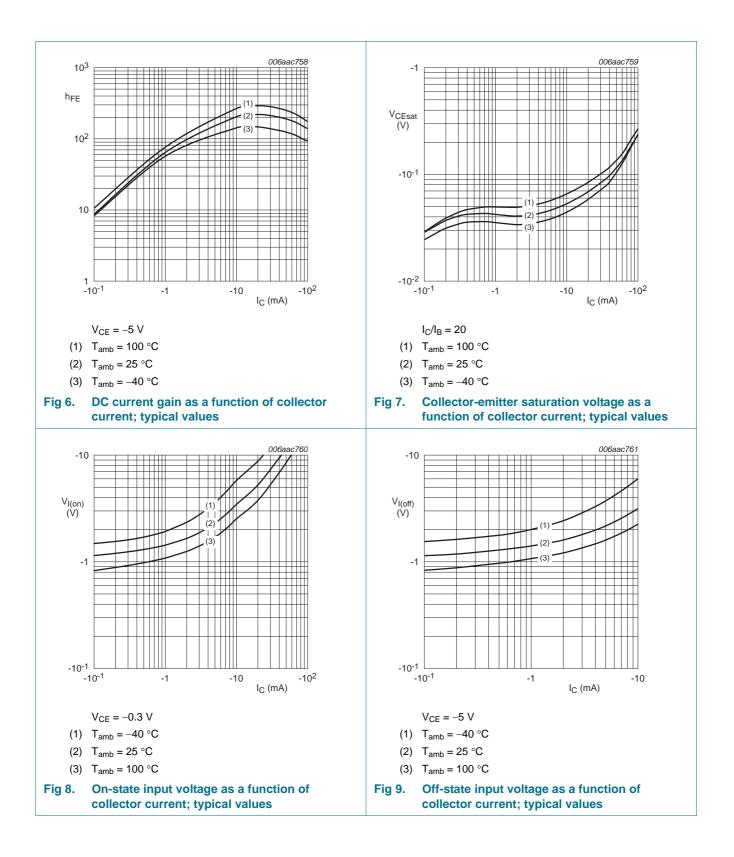
7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{CBO}	collector-base cut-off current	$V_{CB} = -50 \text{ V}; \text{ I}_{E} = 0 \text{ A}$	-	-	-100	nA
I _{CEO}	collector-emitter	V_{CE} = -30 V; I _B = 0 A	-	-	-1	μA
	cut-off current	$V_{CE} = -30$ V; $I_B = 0$ A; $T_j = 150$ °C	-	-	-5	μA
I _{EBO}	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; \text{ I}_{C} = 0 \text{ A}$	-	-	-90	μA
h _{FE}	DC current gain	$V_{CE} = -5 \text{ V}; \text{ I}_{C} = -5 \text{ mA}$	80	-	-	
V _{CEsat}	collector-emitter saturation voltage	$I_{C} = -10 \text{ mA}; I_{B} = -0.5 \text{ mA}$	-	-	-150	mV
V _{I(off)}	off-state input voltage	V_{CE} = –5 V; I_{C} = –100 μA	-	-1.2	-0.8	V
V _{I(on)}	on-state input voltage	V_{CE} = -0.3 V; I _C = -2 mA	-3	-1.6	-	V
R1	bias resistor 1 (input)		33	47	61	kΩ
R2/R1	bias resistor ratio		0.8	1	1.2	
C _c	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 1 MHz	-	-	3	pF
f _T	transition frequency	$V_{CE} = -5 \text{ V}; \text{ I}_{C} = -10 \text{ mA}; $ [1] f = 100 MHz	-	180	-	MHz

[1] Characteristics of built-in transistor

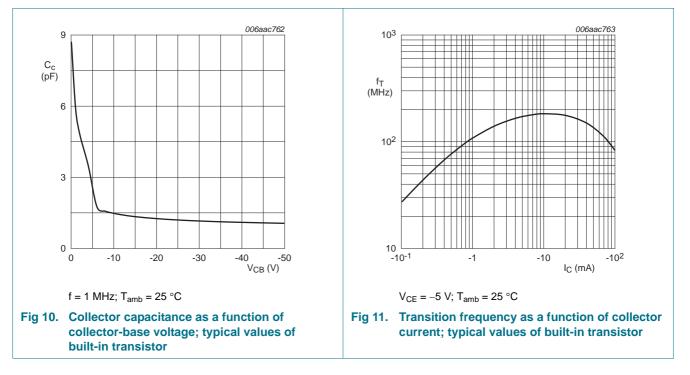
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PDTA144E series



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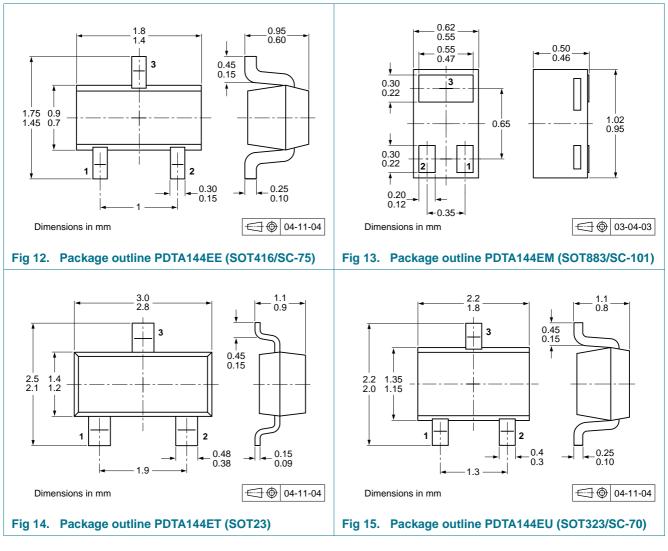
8. Test information

8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

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9. Package outline



10. Packing information

Table 9.Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

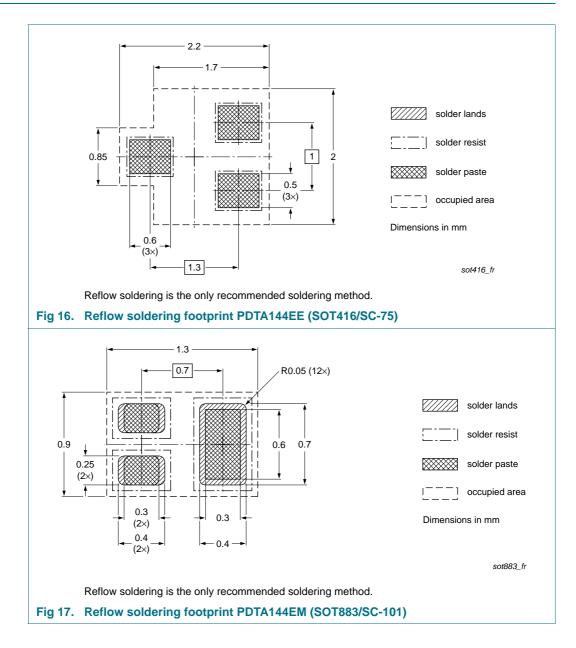
Type number	Package	Description	Packing quantity		
			3000	5000	10000
PDTA144EE	SOT416	4 mm pitch, 8 mm tape and reel	-115	-	-135
PDTA144EM	SOT883	2 mm pitch, 8 mm tape and reel	-	-	-315
PDTA144ET	SOT23	4 mm pitch, 8 mm tape and reel	-215	-	-235
PDTA144EU	SOT323	4 mm pitch, 8 mm tape and reel	-115	-	-135

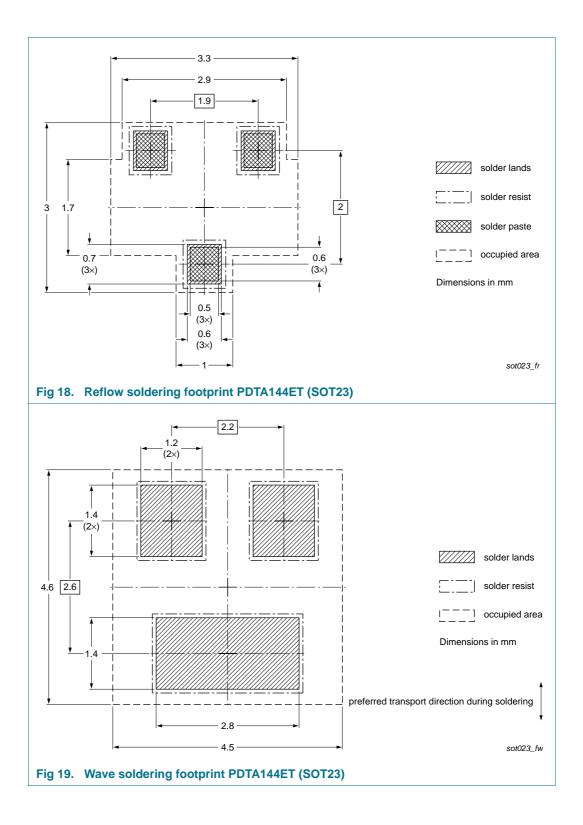
[1] For further information and the availability of packing methods, see Section 14.

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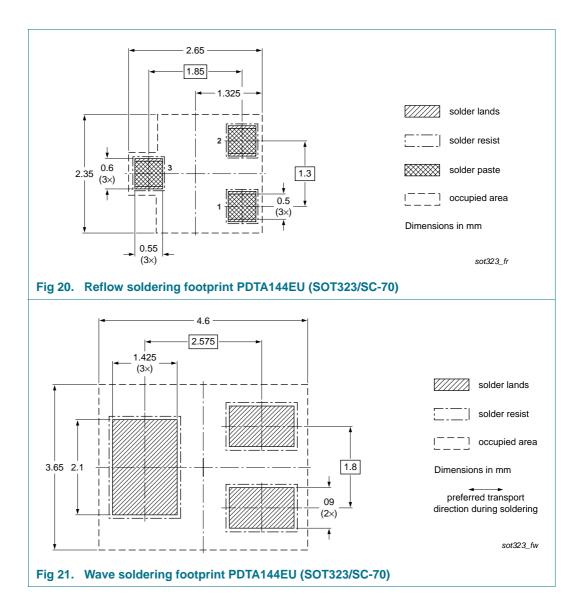
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11. Soldering





PNP resistor-equipped transistors; R1 = 47 k Ω , R2 = 47 k Ω



PDTA144E_SER **Product data sheet**

12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
PDTA144E_SERIES v.8	20111114	Product data sheet	-	PDTA144E_SERIES v.7			
Modifications:	 The format of this document has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 						
	 Legal texts have been adapted to the new company name where appropriate. 						
	 Type numbers PDTA144EEF, PDTA144EK and PDTA144ES removed. 						
	<u>Section 1 "Product profile"</u> : updated						
	<u>Section 3 "Ordering information"</u> : added						
	 <u>Section 4 "Marking"</u>: updated 						
	• Figure 1 to 11: added						
	 Section 6 "Thermal characteristics": updated 						
	 Table 8 "Characteristics": V_{i(on)} redefined to V_{I(on)} on-state input voltage, V_{i(off)} redefined 						
	to $V_{I(off)}$ off-state input voltage, I_{CEO} updated, f_T added						
	<u>Section 8 "Test information"</u> : added						
	 <u>Section 9 "Package outline"</u>: superseded by minimized package outline drawings 						
	 <u>Section 10 "Packing information"</u>: added 						
	 <u>Section 11 "Soldering"</u>: added 						
	 Section 13 * 	Legal information": update	d				
PDTA144E_SERIES v.7	20040805	Product data sheet	-	PDTA144E_SERIES v.6			
PDTA144E SERIES v.6	20030410	Product specification	-	-			

13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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PNP resistor-equipped transistors; R1 = 47 k Ω , R2 = 47 k Ω

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PDTA144E series

PNP resistor-equipped transistors; R1 = 47 k Ω , R2 = 47 k Ω

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Date of release: 14 November 2011 Document identifier: PDTA144E_SER

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